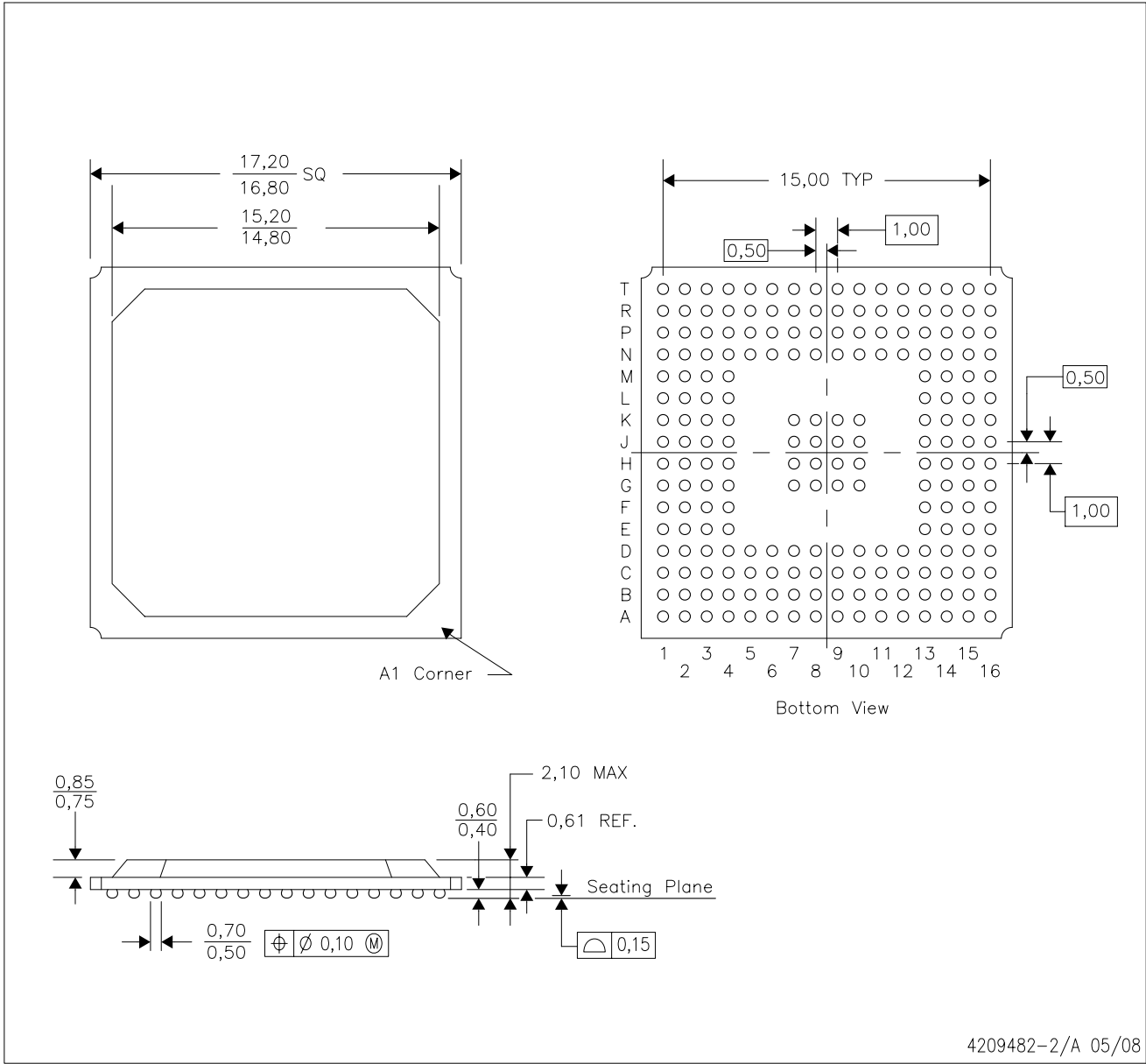


ZFE (S-PBGA-N208)

PLASTIC BALL GRID ARRAY



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Thermally enhanced plastic package.
 - This is a lead-free solder ball design.

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